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PTO/SB/84 (09-04)
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U.S. Patent and Trademark Office; U.S. DEPARTM/ NT OF COMMERCE Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMH control number.

Docket Number (Optional) PETITION FOR REVIVAL OF AN APPLICATION FOR PATENT ABANDONED UNINTENTIONALLY UNDER 37 CFR 1.137(b) First named inventor: Lin You-Tien Art Unit: 3743 Application No.: 10/666,962 Examiner: McKinnon, Torrell L Filed: September 19, 2003 Title: Heat Sink Element Coupling Structure (2) Attention: Office of Petitions Mail Stop Petition Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 FAX (703) 872-9306 NOTE: If information or assistance is needed in completing this form, please contact Petitions Information at (703) 305-9282. The above-identified application became abandoned for failure to file a timely and proper reply to a notice or action by the United States Patent and Trademark Office. The date of abandonment is the day after the expiration date of the period set for reply in the office notice or action plus an extensions of time actually obtained APPLICANT HEREBY PETITIONS FOR REVIVAL OF THIS APPLICATION NOTE: A grantable petition requires the following items: (1) Petition fee: (2) Reply and/or issue fee; (3) Terminal disclaimer with disclaimer fee - required for all utility and plant applications filed before June 8, 1995; and for all design applications; and (4) Statement that the entire delay was unintentional. 1.Petition fee Small entity-fee \$ ______(37 CFR 1.17(m)). Applicant claims small entity status. See 37 CFR 1.27. Other than small entity – fee \$ _____ (37 CFR 1.17(m)) 08/11/2005 TL0111 00000014 10666962 2. Reply and/or fee A. The reply and/or fee to the above-noted Office action in 750.00 OP 01 FC:2452 entify type of reply): the form of Amendments to the claims 1.10 has been filed previously on ___ is enclosed herewith. B. The issue fee and publication fee (if applicable) of \$ ____ has been paid previously on __ is enclosed herewith.

[Page 1 of 8]

This collection of information is required by 37 CFR 1 13/(b). The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 12:2 and 37 CFR 1 11 and 1.14. This collection is estimated to take 1.0 hour to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. An examination of the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1460, Alexandria, VA. 22313-1450, DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Mail Stop Petition, Commissioner for Patents, P.O. Box 1450, Alexandria, VA. 22313-1450.

If you need assistance in completing the form, call 1-800-PTQ-9199 and select option 2.

PTO/SB/64 (09-04)
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Since this utility/plant application was filed	on or after June 8, 1995, no terminal disclaimer is required.
A terminal disclaimer (and disclaimer fee (3 for other than a small entity) disclaiming the PTO/SB/63).	37 CFR 1.20(d)) of \$ for a small entity or \$ e required period of time is enclosed herewith (see
filing of a grantable petition under 37 CFR 1 137	aired reply from the due date for the required reply until the 7(b) was unintentional. [NOTE: The United States Patent and ation if there is a question as to whether either the der 37 CFR 1.137(b) was unintentional (MPEP 711.03(c),
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Lin You-Tie	August 6, 2005
Signature	Date
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Lin You-Tien	Registration Number, if applicable
Typed or printed nam	registration number, ii applicable
P.O. Box 1-252, Sanchung City, Taiw	van. ROC 886-2-2984-0694
Address	Telephone Number
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Additional sheets containing s	statements establishing unintentional delay
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CERTIFICATE OF WITHEIN	NG OR TRANSMISSION [37 CFR 1.8(a)]
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AMENDMENTS TO THE CLAIMS:

Please amend the claims with the ones provided in the listing below wherein status, amendments and cancellations are indicated.

1. (Currently Amended) A heat sink element coupling structure (2), its single heat sink element plate comprised of an L-shaped plate having an a horizontal fold formed along one lateral edge or an a horizontally oriented U-shaped plate having an horizontal folds formed along two lateral edges, including a minimum of one or more coupling structures disposed on the upper and lower or left and right two sides or a certain position at the center portion of said plates, the features of which are:

said coupling structure consists consisting of:

a "7" or a "7" shaped an ascending-stepped or a descending-stepped horizontal offset formed on the lateral edge of said plates:

an inverted U-shaped or a U-shaped appendages appendage situated at the anterior section of said ascending-stepped or said descending-stepped horizontal offsets offset;

one or two wing-shaped lock tabs formed at the two sides or either the left or the right side of said inverted U-shaped or said U-shaped appendages appendage:

when interconnected, one or two said wing-shaped lock tabs of each said coupling structure at the two sides of one heat sink unit (element) are fitted onto said "¬" or "¬" shaped ascending-stepped or descending-stepped horizontal offsets of the next correspondingly situated said heat sink unit (element) such that the one or two said wing-shaped lock tabs on said front heat sink unit (element) becomes engaged onto the lateral edge of the

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adjacent other said heat sink unit (element) at fixed horizontal distances and positions.

2. (Canceled) A heat sink element coupling structure (2), its single heat sink element plate comprised of an L-shaped plate having an horizontal fold formed along one lateral edge or a horizontally oriented U-shaped plate having an horizontal fold formed along two lateral edges, including a minimum of one or more coupling structures disposed on the upper and lower or left and right two sides or a certain position at the center portion of said plates, the features of which are:

said coupling structure consists of:

a "¬" or a "¬" -shaped horizontal offset formed on two lateral edges of said plates;

one or two cutaways at the two sides or either the left or the right side of said horizontal offsets, and a downward or upward lock tab at the two sides or the either left or right of the unterior section of said horizontal offsets; when interconnected, one or two said lock tabs of each said coupling structure on one heat sink unit (element) are fitted onto said horizontal offsets of the next correspondingly situated said heat sink unit (element) such that the one or two said lock tabs of said coupling structure on said front heat sink unit (element) become engaged onto the upper and lateral said horizontal offsets and or said cutaway at the two sides of the adjacent other said heat sink unit (element) at fixed horizontal distances and positions.

 (Currently Amended) As mentioned in Claim 1 of the heat sink element coupling structure (2) invention herein, the features include: wherein each

said wing-shaped lock tab has a vertical lock edge disposed downward or upward on its rear side.

- 4. (Currently Amended) As mentioned in Claim 1 of the heat sink element coupling structure (2) invention herein, the features include: , wherein the anterior section of each said "" or " " shaped ascending-stepped or descending-stepped horizontal offset does not have to be folded into said inverted U-shaped or U-shaped appendages appendage, and a vertical lock tab is folded downward or upward at the rear sides of the two said wing-shaped lock tabs.
- 5. (Currently Amended) As mentioned in Claim 1. Claim 3, and Claim 4 of the heat sink element coupling structure (2) invention herein, wherein each said coupling structure only has a single said wing-shaped lock tab at the anterior half sections of its said "¬" or "¬" shaped ascending-stepped or descending-stepped horizontal offsets.
- 6. (Currently Amended) As mentioned in Claim 5 of the heat sink element coupling structure (2) invention herein, wherein a said cutaway is disposed between said ascending-stepped or descending-stepped horizontal offset having a of an inner side single said wing shaped lock tab at the inner side thereof and said L-shaped or horizontally oriented U-shaped plates; disposed between said horizontal offset having a of an outer side single said wing-shaped lock tab at the outer side thereof and the said L-shaped or horizontally oriented U-shaped plates the said horizontal fold formed along said L-shaped or horizontally oriented U-shaped plates horizontally folded

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planar member is a locating notch.

- 7. (Original) As mentioned in Claim 1 and Claim 3 of the heat sink element coupling structure (2) invention herein, said L-shaped plate lacks a said horizontal fold and has a minimum of one narrow horizontal fold disposed at a position near a said coupling structure.
- 8. (Currently Amended) As mentioned in Claim 2 of the The heat sink element coupling structure (2) of Claim 1 invention herein, wherein the posterior half sections of said upper "¬" or the upper "¬" shaped ascending-stepped or descending-stepped horizontal offsets include first disposing two said locating notches or two said cutaways, or downward and upward indentations on their upper and lower said horizontal folds and then forming the upper and the lower said ascending-stepped or descending-stepped horizontal offsets.
- 9. (Cancelled) As mentioned in Claim 2 of the heat sink element coupling structure (2) invention herein, said coupling structure horizontal offsets includes direct situating on the upper edge of said L shaped plate.
- 10. (Currently Amended) As mentioned in Claim 1 and Claim 2 of the heat sink element coupling structure (2)—invention herein, said L-shaped plate or said horizontally oriented U-shaped plate s have has a plurality of holes.

P:008

AUG 0 5 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of:

Lin You-Tien

Serial No.: 10/666,962

Filed: Sep. 19, 2003

Examiner: McKinnon, Terrell L

Group Art Unit: 3743 Confirmation No. 9515

Petition to Withdraw Holding of Abandonment

Office of Petitions

August 6, 2005

Mail Stop Petition

Commissioner for Patents

Via Facsimile

P.O. Box 1450

Alexandria, VA. 22313-1450, USA

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Dear Sir(s):

In response to the Notice of Abandonment mailed on July 13, 2005, we hereby file a petition to request the above-identified application be revived on the grounds of UNINTENTIONAL DELAY under 37 CFR 1.137(b). Please withdraw the holding of abandonment with the required petition fee \$750 set forth in 37 CFR 1.17(m).

According to the Notice of Abandonment, the application was abandoned for failure to timely file the Petition for One-month Extension of Time for the amendment received on September 27, 2004. On July 21, 2005, we fax a Credit Card Payment Form of \$60 for one-month extension fee and that's a mistaken amount for revival of unintentionally abandoned application. Instead, we fax a new Credit Card Payment Form of \$750 for small entity.

If there's any question, please contact Ms. Elaine Lin at +886-2-2984-0694; our facsimile number is +886-2-2984-9030. Thank you for your generous help.